



PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00474	REV: E2	SVN REV: Not In VersionControl
PLOT NAME = Top Layer Assembly Drawing	GENERATED : 9/30/2015 5:05:47 PM	TEXAS INSTRUMENTS	

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PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00474	REV: E2	SVN REV: Not In VersionControl
PLOT NAME = Bottom Layer Assembly Drawing	GENERATED : 9/30/2015 5:05:47 PM	TEXAS INSTRUMENTS	

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